

SD103ASDM

SURFACE MOUNT SCHOTTKY BARRIER DIODE ARRAY

Features

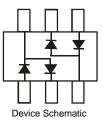
- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Fast Switching
- Low Reverse Capacitance
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device, (Note 4 and 5)

Mechanical Data

- Case: SOT-26
- Case Material: Molded Plastic, "Green" Molding Compound, • Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Polarity: See Diagram
- Leads: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Copper leadframe).
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.016 grams (approximate)



Top View



Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	v
RMS Reverse Voltage	V _{R(RMS)}	28	V
Forward Continuous Current (Note 1)	I _{FM}	350	mA
Non-Repetitive Peak Forward Surge Current $@ t \le 1.0s$	I _{FSM}	1.5	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	PD	225	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	$R_{\theta JA}$	444	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +125	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V _{(BR)R}	40		—	V	I _R = 100μA
				0.37		$I_F = 20 \text{mA}$
Forward Voltage Drop	VF	—	—	0.50 0.60		I _F = 100mA
						I _F = 200mA
Reverse Current (Note 2)	I _R	_		5.0	μΑ	$V_R = 30V$
Total Capacitance	CT	_	50		pF	$V_{R} = 0V, f = 1.0MHz$
Reverse Recovery Time			10	_	ns	$I_{\rm F} = I_{\rm R} = 200 {\rm mA},$
Reverse Recovery Time	t _{rr}		10			$I_{rr} = 0.1 \times I_R, R_L = 100\Omega$

Notes: 1. Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

Short duration pulse test used to minimize self-heating effect. 2

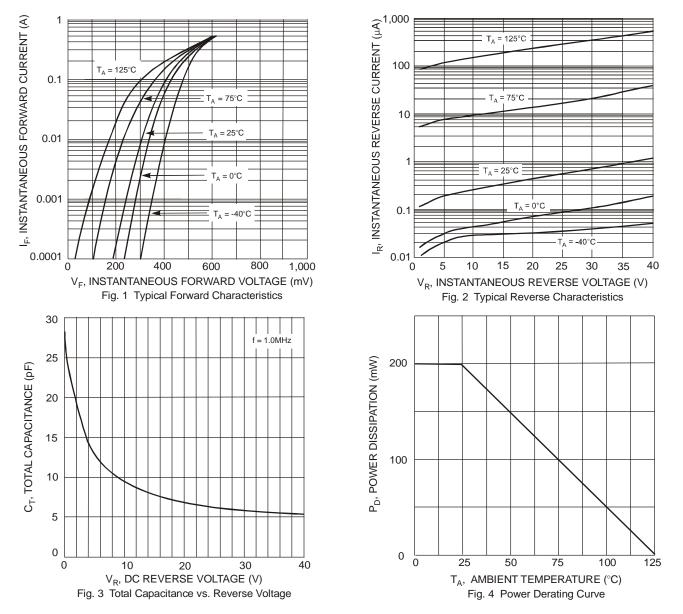
3. No purposefully added lead.

4.

Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date 5. Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



SD103ASDM



Ordering Information (Notes 5 & 6)

Part Number	Case	Packaging
SD103ASDM-7-F	SOT-26	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

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KSU YM										
KSU YM										
Π										

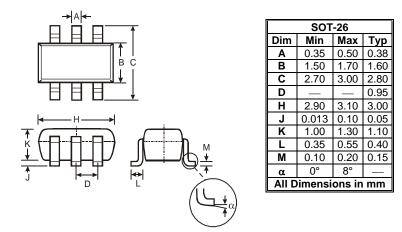
KSU = Product Type Marking Code YM = Date Code Marking Y =Year (ex: T = 2006) M = Month (ex: 9 = September)

Date Code Key

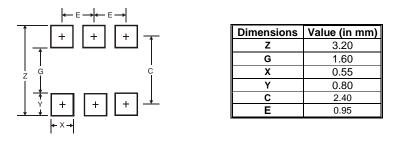
Year	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	Ν	Р	R	S	Т	U	V	W	Х	Y	Z	Α	В	С
Month	Jan	Feb	Ma	ar /	Apr	May	Jun	Jul	Aug	Se	p (Oct	Nov	Dec
Code	1	2	3		4	5	6	7	8	9		0	N	D



Package Outline Dimensions



Suggested Pad Layout



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